# 2SK0657 (2SK657)

# Silicon N-Channel MOS FET

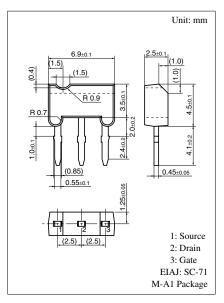
### For switching

#### ■ Features

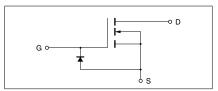
- High-speed switching
- M type package, allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

## ■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit	
Drain to Source breakdown voltage	V <sub>DSS</sub>	50	V	
Gate to Source voltage	$V_{GSO}$	8	V	
Drain current	$I_D$	±100	mA	
Max drain current	$I_{DP}$	±200	mA	
Allowable power dissipation	$P_{\mathrm{D}}$	400	mW	
Channel temperature	T <sub>ch</sub>	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	



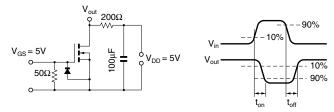
#### Internal Connection



### ■ Electrical Characteristics (Ta = 25°C)

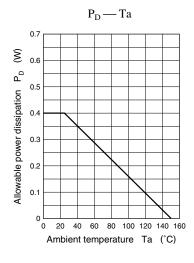
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	$I_{DSS}$	$V_{DS} = 10V, V_{GS} = 0$			10	μΑ
Gate to Source leakage current	$I_{GSS}$	$V_{GS} = 8V, V_{DS} = 0$			50	μA
Drain to Source breakdown voltage	V <sub>DSS</sub>	$I_D = 100 \mu A, V_{GS} = 0$	50			V
Gate threshold voltage	$V_{th}$	$I_D = 100\mu A, V_{DS} = V_{GS}$	1.5		3.5	V
Drain to Source ON-resistance	R <sub>DS(on)</sub>	$I_D = 20 \text{mA}, V_{GS} = 5 \text{V}$			50	Ω
Forward transfer admittance	Y <sub>fs</sub>	$I_D = 20 \text{mA}, V_{DS} = 5 \text{V}, f = 1 \text{kHz}$	20			mS
Input capacitance (Common Source)	C <sub>iss</sub>				15	pF
Output capacitance (Common Source)	Coss	$V_{DS} = 5V, V_{GS} = 0, f = 1MHz$			6	pF
Reverse transfer capacitance (Common Source)	C <sub>rss</sub>				1.2	pF
Turn-on time	t <sub>on</sub> *	$V_{DD} = 5V, V_{GS} = 0 \text{ to } 5V, R_{L} = 200\Omega$		10		ns
Turn-off time	t <sub>off</sub> *	$V_{DD} = 5V$ , $V_{GS} = 5$ to $0V$ , $R_L = 200\Omega$		20		ns

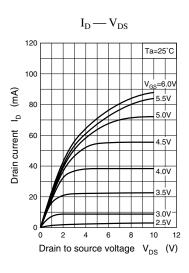
<sup>\*</sup> t<sub>on</sub>, t<sub>off</sub> measurement circuit

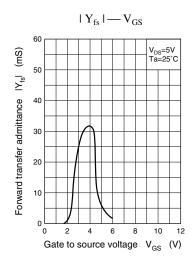


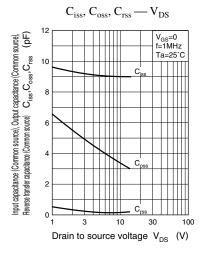
Note) The part number in the parenthesis shows conventional part number.

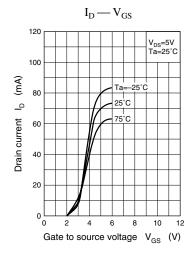
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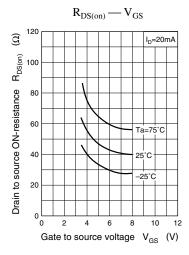


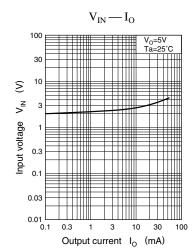












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